Quad D-type flip-flop with reset; positive-edge triggerRev. 4 — 8 April 2014Product of

Product data sheet

1. **General description**

The 74HC175; 74HCT175 are quad positive edge-triggered D-type flip-flops with individual data inputs (Dn) and both Qn and Qn outputs. The common clock (CP) and master reset (MR) inputs load and reset all flip-flops simultaneously. The D-input that meets the set-up and hold time requirements on the LOW-to-HIGH clock transition is stored in the flip-flop and appears at the Q output. A LOW on MR causes the flip-flops and outputs to be reset LOW.

The device is useful for applications where both the true and complement outputs are required and the clock and master reset are common to all storage elements.

Features and benefits 2.

- Input levels:
 - For 74HC175: CMOS level
 - For 74HCT175: TTL level
- Four edge-triggered D-type flip-flops
- Asynchronous master reset
- Complies with JEDEC standard no. 7A
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V.
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C.

Ordering information 3.

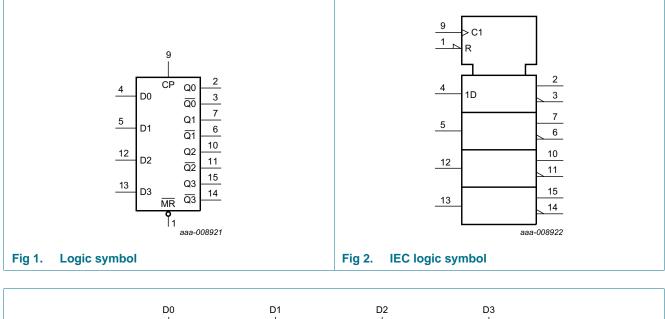
Table 1. **Ordering information**

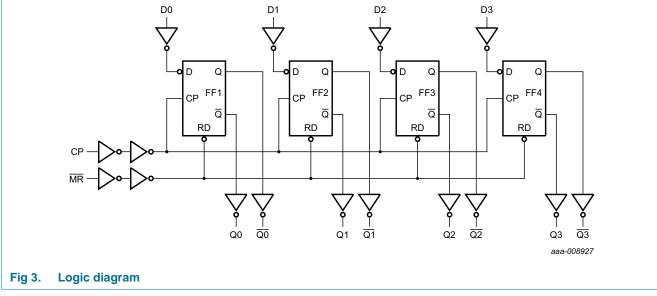
| Type number | Package | | | |
|-------------|-------------------|---------|--|----------|
| | Temperature range | Name | Description | Version |
| 74HC175N | –40 °C to +125 °C | DIP16 | plastic dual in-line package; 16 leads (300 mil) | SOT38-4 |
| 74HCT175N | _ | | | |
| 74HC175D | –40 °C to +125 °C | SO16 | plastic small outline package; 16 leads; body width | SOT109-1 |
| 74HCT175D | _ | | 3.9 mm | |
| 74HC175DB | –40 °C to +125 °C | SSOP16 | plastic shrink small outline package; 16 leads; | SOT338-1 |
| 74HCT175DB | | | body width 5.3 mm | |
| 74HC175PW | –40 °C to +125 °C | TSSOP16 | plastic thin shrink small outline package; 16 leads; | SOT403-1 |
| 74HCT175PW | - | | body width 4.4 mm | |



Quad D-type flip-flop with reset; positive-edge trigger

4. Functional diagram

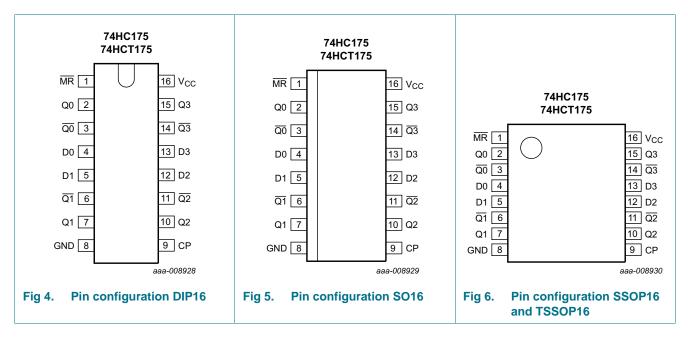




Quad D-type flip-flop with reset; positive-edge trigger

5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2.Pin description

| Symbol | Pin | Description | |
|-----------------|--------------|--|--|
| MR | 1 | asynchronous master reset input (active LOW) | |
| Q0 to Q3 | 2, 7, 10, 15 | flip-flop output | |
| Q0 to Q3 | 3, 6, 11, 14 | complementary flip-flop output | |
| D0 to D3 | 4, 5, 12, 13 | data input | |
| GND | 8 | ground (0 V) | |
| СР | 9 | clock input (LOW-to-HIGH edge-triggered) | |
| V _{CC} | 16 | positive supply voltage | |

Quad D-type flip-flop with reset; positive-edge trigger

6. Functional description

Table 3.Function table^[1]

| Operating modes | Inputs | | | Outputs | | |
|-----------------|--------|----|----|---------|----|--|
| | MR | СР | Dn | Qn | Qn | |
| reset (clear) | L | Х | Х | L | Н | |
| load "1" | Н | ↑ | h | Н | L | |
| load "0" | Н | ↑ | I | L | Н | |

[1] H = HIGH voltage level;

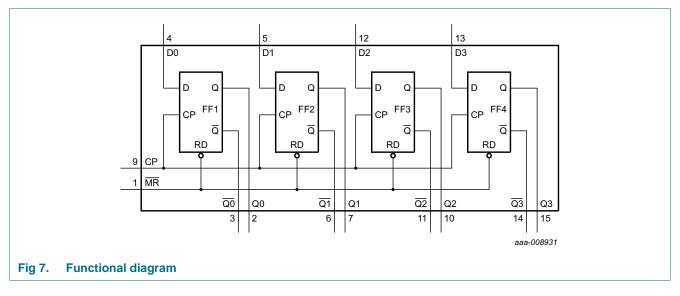
h = HIGH voltage level one set-up time prior to the LOW-to-HIGH clock transition;

L = LOW voltage level;

I = LOW voltage level one set-up time prior to the LOW-to-HIGH clock transition;

X = don't care;

 \uparrow = LOW-to-HIGH clock transition.



7. Limiting values

Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V)

| Symbol | Parameter | Conditions | Min | Max | Unit |
|------------------|-------------------------|---|------|------|------|
| V _{CC} | supply voltage | | -0.5 | +7 | V |
| I _{IK} | input clamping current | $V_{I} < -0.5 \text{ V or } V_{I} > V_{CC} + 0.5 \text{ V}$ | - | ±20 | mA |
| I _{OK} | output clamping current | V_{O} < -0.5 V or V_{O} > V_{CC} + 0.5 V | - | ±20 | mA |
| lo | output current | $-0.5 \text{ V} < \text{V}_{\text{O}} < \text{V}_{\text{CC}} + 0.5 \text{ V}$ | - | ±25 | mA |
| I _{CC} | supply current | | - | 50 | mA |
| I _{GND} | ground current | | -50 | - | mA |
| T _{stg} | storage temperature | | -65 | +150 | °C |

74HC_HCT175 Product data sheet

Quad D-type flip-flop with reset; positive-edge trigger

Table 4. Limiting values ... continued

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V)

| | | - · · · | | | | |
|------------------|-------------------------|---|-----|-----|------|----|
| Symbol | Parameter | Conditions | Min | Max | Unit | |
| P _{tot} | total power dissipation | $T_{amb} = -40 \ ^{\circ}C \ to +125 \ ^{\circ}C$ | | | | |
| | | DIP16 package | [1] | - | 750 | mW |
| | | SO16, SSOP16 and TSSOP16 | [2] | - | 500 | mW |

[1] For DIP16 package: above 70 °C the value of Ptot derates linearly with 12 mW/K.

[2] For SO16 package: above 70 °C the value of Ptot derates linearly with 8 mW/K.

For SSOP16 and TSSOP16 packages: above 60 °C the value of Ptot derates linearly with 5.5 mW/K.

Recommended operating conditions 8.

Table 5. **Recommended operating conditions**

Voltages are referenced to GND (ground = 0 V)

| Symbol | Parameter | Conditions | 74HC | 175 | | 74HC | T175 | | Unit |
|------------------|-------------------------------------|------------------|------|------|-----------------|------|------|-----------------|------|
| | | | Min | Тур | Max | Min | Тур | Max | |
| V _{CC} | supply voltage | | 2.0 | 5.0 | 6.0 | 4.5 | 5.0 | 5.5 | V |
| VI | input voltage | | 0 | - | V _{CC} | 0 | - | V _{CC} | V |
| Vo | output voltage | | 0 | - | V _{CC} | 0 | - | V _{CC} | V |
| T _{amb} | ambient temperature | | -40 | - | +125 | -40 | - | +125 | °C |
| Δt/ΔV | input transition rise and fall rate | $V_{CC} = 2.0 V$ | - | - | 625 | - | - | - | ns/V |
| | | $V_{CC} = 4.5 V$ | - | 1.67 | 139 | - | 1.67 | 139 | ns/V |
| | | $V_{CC} = 6.0 V$ | - | - | 83 | - | - | - | ns/V |

Static characteristics 9.

Table 6. **Static characteristics**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | | 25 °C | | −40 °C | to +85 °C | -40 °C t | to +125 °C | Unit |
|-----------------|-------------------------|--|------|-------|------|---------------|-----------|----------|------------|------|
| | | | Min | Тур | Max | Min | Max | Min | Max | |
| 74HC17 | 5 | | 1 | -1 | -1 | | | 1 | | |
| VIH | HIGH-level | V _{CC} = 2.0 V | 1.5 | 1.2 | - | 1.5 | - | 1.5 | - | V |
| | input voltage | V _{CC} = 4.5 V | 3.15 | 2.4 | - | 3.15 | - | 3.15 | - | V |
| | | V _{CC} = 6.0 V | 4.2 | 3.2 | - | 4.2 | - | 4.2 | - | V |
| V _{IL} | LOW-level input voltage | V _{CC} = 2.0 V | - | 0.8 | 0.5 | - | 0.5 | - | 0.5 | V |
| | | V _{CC} = 4.5 V | - | 2.1 | 1.35 | - | 1.35 | - | 1.35 | V |
| | | V _{CC} = 6.0 V | - | 2.8 | 1.8 | - | 1.8 | - | 1.8 | V |
| V _{OH} | HIGH-level | $V_{I} = V_{IH} \text{ or } V_{IL}$ | | | | | | | | |
| | output voltage | $I_0 = -20 \ \mu\text{A}; \ V_{CC} = 2.0 \ \text{V}$ | 1.9 | 2.0 | - | 1.9 | - | 1.9 | - | V |
| | | $I_0 = -20 \ \mu\text{A}; \ V_{CC} = 4.5 \ \text{V}$ | 4.4 | 4.5 | - | 4.4 | - | 4.4 | - | V |
| | | $I_0 = -20 \ \mu\text{A}; \ V_{CC} = 6.0 \ \text{V}$ | 5.9 | 6.0 | - | 5.9 | - | 5.9 | - | V |
| | - | $I_0 = -4.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$ | 3.98 | 4.32 | - | 3.84 | - | 3.7 | - | V |
| | | $I_{\rm O}$ = -5.2 mA; $V_{\rm CC}$ = 6.0 V | 5.48 | 5.81 | - | 5.34 | - | 5.2 | - | V |

| 74HC_HCT175 | All information provided in this document is subject to legal disclaimers. | © NXP Semiconductors N.V. 2014. All rights reserved. |
|--------------------|--|--|
| Product data sheet | Rev. 4 — 8 April 2014 | 5 of 19 |

Quad D-type flip-flop with reset; positive-edge trigger

Table 6. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | | 25 °C | | -40 °C | to +85 °C | –40 °C t | o +125 °C | Unit |
|------------------|------------------------------|---|------|-------|------|--------|-----------|----------|-----------|------|
| | | | Min | Тур | Max | Min | Max | Min | Мах | |
| V _{OL} | LOW-level | $V_{I} = V_{IH} \text{ or } V_{IL}$ | | | | | | | | |
| | output voltage | $I_{O} = 20 \ \mu A; V_{CC} = 2.0 \ V$ | - | 0 | 0.1 | - | 0.1 | - | 0.1 | V |
| | | I_{O} = 20 μ A; V_{CC} = 4.5 V | - | 0 | 0.1 | - | 0.1 | - | 0.1 | V |
| | | $I_{O} = 20 \ \mu A; V_{CC} = 6.0 \ V$ | - | 0 | 0.1 | - | 0.1 | - | 0.1 | V |
| | | I_{O} = 4.0 mA; V_{CC} = 4.5 V | - | 0.15 | 0.26 | - | 0.33 | - | 0.4 | V |
| | | $I_{O} = 5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$ | - | 0.16 | 0.26 | - | 0.33 | - | 0.4 | V |
| I | input leakage current | $V_I = V_{CC}$ or GND; $V_{CC} = 6.0 V$ | - | - | ±0.1 | - | ±1 | - | ±1 | μA |
| I _{CC} | supply current | | - | - | 8.0 | - | 80 | - | 160 | μA |
| CI | input capacitance | | - | 3.5 | - | - | - | - | - | pF |
| 74HCT1 | 75 | | | | | | | 1 | | |
| V _{IH} | HIGH-level input voltage | V_{CC} = 4.5 V to 5.5 V | 2.0 | 1.6 | - | 2.0 | - | 2.0 | - | V |
| V _{IL} | LOW-level input voltage | V_{CC} = 4.5 V to 5.5 V | - | 1.2 | 0.8 | - | 0.8 | - | 0.8 | V |
| V _{OH} | HIGH-level | $V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$ | | | | | | | | |
| | output voltage | I _O = -20 μA | 4.4 | 4.5 | - | 4.4 | - | 4.4 | - | V |
| | | I _O = -4.0 mA | 3.98 | 4.32 | - | 3.84 | - | 3.7 | - | V |
| V _{OL} | LOW-level | $V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$ | | | | | | | | |
| | output voltage | $I_0 = 20 \ \mu\text{A}; \ V_{CC} = 4.5 \ \text{V}$ | - | 0 | 0.1 | - | 0.1 | - | 0.1 | V |
| | | I_{O} = 5.2 mA; V_{CC} = 5.5 V | - | 0.15 | 0.26 | - | 0.33 | - | 0.4 | V |
| I | input leakage current | $V_1 = V_{CC}$ or GND; $V_{CC} = 5.5 V$ | - | - | ±0.1 | - | ±1 | - | ±1 | μA |
| I _{CC} | supply current | $V_{I} = V_{CC} \text{ or GND; } I_{O} = 0 \text{ A;}$ $V_{CC} = 5.5 \text{ V}$ | - | - | 8.0 | - | 80 | - | 160 | μA |
| ΔI _{CC} | additional supply current | per input pin; $V_I = V_{CC} - 2.1 V$; other inputs at V_{CC} or GND; $V_{CC} = 4.5 V$ to 5.5 V | | | | | | | | |
| | | Dn input | - | 40 | 144 | - | 180 | - | 196 | μΑ |
| | | CP input | - | 60 | 216 | - | 270 | - | 294 | μΑ |
| | | MR input | - | 100 | 360 | - | 450 | - | 490 | μΑ |
| Cı | input capacitance | | - | 3.5 | - | - | - | - | - | pF |

Quad D-type flip-flop with reset; positive-edge trigger

10. Dynamic characteristics

Table 7. Dynamic characteristics

GND (ground = 0 V); $C_L = 50 \text{ pF}$ unless otherwise specified; for test circuit, see Figure 11

| Symbol | Parameter | Conditions | | 25 °C | ; | −40 °C | to +85 °C | –40 °C t | to +125 °C | Unit |
|--------|-------------------------|---|-----------|-------|-----|---------------|-----------|----------|------------|------|
| | | | Min | Тур | Мах | Min | Max | Min | Мах | |
| 74HC17 | 5 | | | | | | | 1 | | |
| pd | propagation delay | CP to Qn, Qn; [1] see Figure 8 | 1 | | | | | | | |
| | | V _{CC} = 2.0 V | - | 55 | 175 | - | 220 | - | 265 | ns |
| | | $V_{CC} = 4.5 V$ | - | 20 | 35 | - | 44 | - | 53 | ns |
| | | V _{CC} = 5 V; C _L = 15 pF | - | 17 | - | - | - | - | - | ns |
| | | $V_{CC} = 6.0 V$ | - | 16 | 30 | - | 37 | - | 45 | ns |
| PHL | HIGH to LOW propagation | MR to Qn, Qn; see Figure 10 | | | | | | | | |
| | delay | V _{CC} = 2.0 V | - | 50 | 150 | - | 190 | - | 225 | ns |
| | | V _{CC} = 4.5 V | - | 18 | 30 | - | 38 | - | 45 | ns |
| | | $V_{CC} = 5 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$ | - | 15 | - | - | - | - | - | ns |
| | | $V_{CC} = 6.0 V$ | - | 14 | 26 | - | 33 | - | 38 | ns |
| t | transition time | Qn output; see Figure 8 | <u>2]</u> | | | | | | | |
| | | V _{CC} = 2.0 V | - | 19 | 75 | - | 95 | - | 110 | ns |
| | | V _{CC} = 4.5 V | - | 7 | 15 | - | 19 | - | 22 | ns |
| | | V _{CC} = 6.0 V | - | 6 | 13 | - | 16 | - | 19 | ns |
| W | pulse width | CP input HIGH or LOW; see Figure 8 | | | | | | | | |
| | | V _{CC} = 2.0 V | 80 | 22 | - | 100 | - | 120 | - | ns |
| | | $V_{CC} = 4.5 V$ | 16 | 8 | - | 20 | - | 24 | - | ns |
| | | V _{CC} = 6.0 V | 14 | 6 | - | 17 | - | 20 | - | ns |
| | | MR input LOW; see Figure 10 | | | | | | | | |
| | | V _{CC} = 2.0 V | 80 | 19 | - | 100 | - | 120 | - | ns |
| | | V _{CC} = 4.5 V | 16 | 7 | - | 20 | - | 24 | - | ns |
| | | V _{CC} = 6.0 V | 14 | 6 | - | 17 | - | 20 | - | ns |
| rec | recovery time | MR to CP; see Figure 10 | | | | | | | | |
| | | V _{CC} = 2.0 V | 5 | -33 | - | 5 | - | 5 | - | ns |
| | | $V_{CC} = 4.5 V$ | 5 | -12 | - | 5 | - | 5 | - | ns |
| | | V _{CC} = 6.0 V | 5 | -10 | - | 5 | - | 5 | - | ns |
| su | set-up time | Dn to CP; see Figure 8 | | | | | | | | |
| | | V _{CC} = 2.0 V | 80 | 3 | - | 100 | - | 120 | - | ns |
| | | V _{CC} = 4.5 V | 16 | 1 | - | 20 | - | 24 | - | ns |
| | | V _{CC} = 6.0 V | 14 | 1 | - | 17 | - | 20 | - | ns |

Quad D-type flip-flop with reset; positive-edge trigger

| Symbol | Parameter | Conditions | | 25 °C | ; | –40 °C | to +85 °C | –40 °C to +125 °C | | Unit |
|------------------|-------------------------------------|---|------|-------|-----|--------|-----------|-------------------|-----|------|
| | | | Min | Тур | Мах | Min | Мах | Min | Мах | |
| t _h | hold time | Dn to CP; see Figure 8 | | | | | | | | |
| | | V _{CC} = 2.0 V | 25 | 2 | - | 30 | - | 40 | - | ns |
| | | V _{CC} = 4.5 V | 5 | 0 | - | 6 | - | 8 | - | ns |
| | | $V_{CC} = 6.0 V$ | 4 | 0 | - | 5 | - | 7 | - | ns |
| f _{max} | maximum | CP input; see Figure 8 | | | | | | | | |
| | frequency | V _{CC} = 2.0 V | 6 | 25 | - | 4.8 | - | 4 | - | MHz |
| | | V _{CC} = 4.5 V | 30 | 75 | - | 24 | - | 20 | - | MHz |
| | | $V_{CC} = 5 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$ | - | 83 | - | - | - | - | - | MHz |
| | | V _{CC} = 6.0 V | 35 | 89 | - | 28 | - | 24 | - | MHz |
| C _{PD} | power dissipation capacitance | per package; I $V_1 = GND$ to V_{CC} | 3] - | 32 | - | - | - | - | - | pF |
| 74HCT17 | 75 | | | | | | | | | |
| t _{pd} | propagation delay | CP to Qn, Qn; I see Figure 8 | 1] | | | | | | | |
| | | V _{CC} = 4.5 V | - | 19 | 33 | - | 41 | - | 50 | ns |
| | | V _{CC} = 5 V; C _L = 15 pF | - | 16 | - | - | - | - | - | ns |
| t _{PHL} | HIGH to LOW | MR to Qn; see Figure 10 | | | | | | | | |
| | propagation | V _{CC} = 4.5 V | - | 22 | 38 | - | 48 | - | 57 | ns |
| | delay | $V_{CC} = 5 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$ | - | 19 | - | - | - | - | - | ns |
| | | MR to Qn; see Figure 10 | | | | | | | | |
| | | V _{CC} = 4.5 V | - | 19 | 35 | - | 44 | - | 53 | ns |
| | | $V_{CC} = 5 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$ | - | 16 | - | - | - | - | - | ns |
| t _t | transition time | Qn output; see Figure 8 | 2] | | | | | | | |
| | | V _{CC} = 4.5 V | - | 7 | 15 | - | 19 | - | 22 | ns |
| t _W | pulse width | CP input; see Figure 8 | | | | | | | | |
| | | V _{CC} = 4.5 V | 20 | 12 | - | 25 | - | 30 | - | ns |
| | | MR input LOW; see Figure 10 | | | | | | | | |
| | | V _{CC} = 4.5 V | 20 | 11 | - | 25 | - | 30 | - | ns |
| t _{rec} | recovery time | MR to CP; see Figure 10 | | | | | | | | |
| | | V _{CC} = 4.5 V | 5 | -10 | - | 5 | - | 5 | - | ns |
| t _{su} | set-up time | Dn to CP; see Figure 8 | | | | | | | | |
| | | V _{CC} = 4.5 V | 16 | 5 | - | 20 | - | 24 | - | ns |
| t _h | hold time | Dn to CP; see Figure 8 | | | | | | | | |
| | | V _{CC} = 4.5 V | 5 | 0 | - | 5 | - | 5 | - | ns |

Table 7. Dynamic characteristics ...continued

GND (ground = 0 V); $C_L = 50 \text{ pF}$ unless otherwise specified; for test circuit, see Figure 11

Quad D-type flip-flop with reset; positive-edge trigger

| Symbol | Parameter Conditions | | | 25 °C | | | to +85 °C | –40 °C t | Unit | |
|------------------|-------------------------------------|---|-----|-------|-----|-----|-----------|----------|------|-----|
| | | | Min | Тур | Max | Min | Max | Min | Max | |
| f _{max} | maximum | CP input; see Figure 8 | | | | | | | | |
| f | frequency | V _{CC} = 4.5 V | 25 | 49 | - | 20 | - | 17 | - | MHz |
| | | $V_{CC} = 5 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$ | - | 54 | - | - | - | - | - | MHz |
| C _{PD} | power dissipation capacitance | per package; V _I = GND to V _{CC} – 1.5 V | 1 - | 34 | - | - | - | - | - | pF |

Table 7. Dynamic characteristics ...continued

GND (ground = 0 V); C_L = 50 pF unless otherwise specified; for test circuit, see Figure 11

- [1] t_{pd} is the same as t_{PHL} and t_{PLH} .
- $\label{eq:ttilde} [2] \quad t_t \text{ is the same as } t_{THL} \text{ and } t_{TLH}.$

[3] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i + \Sigma (C_L \times V_{CC}^2 \times f_o)$ where:

 f_i = input frequency in MHz;

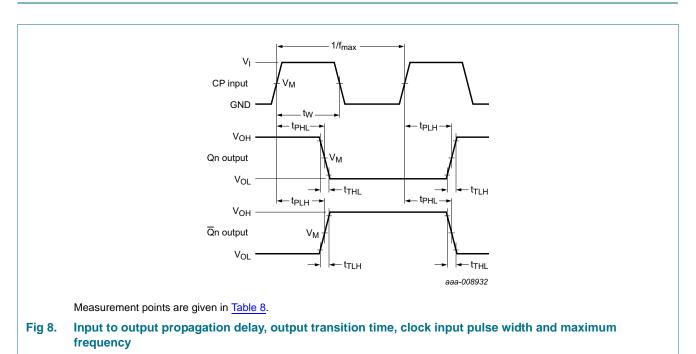
fo = output frequency in MHz;

 $\Sigma (C_L \times V_{CC}^2 \times f_o)$ = sum of outputs;

 C_L = output load capacitance in pF;

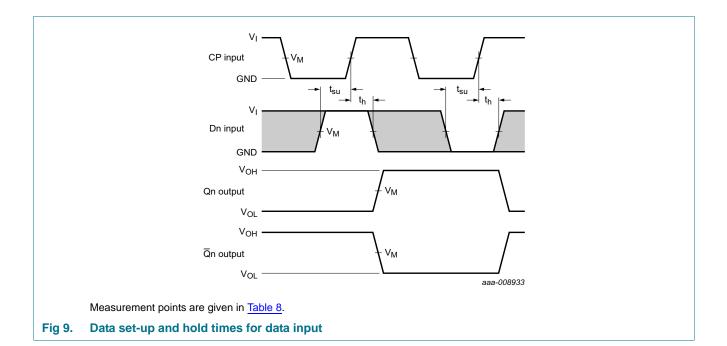
 V_{CC} = supply voltage in V.

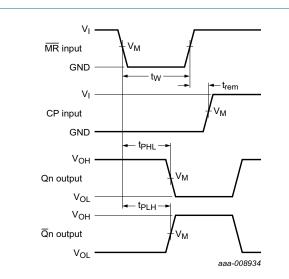
11. Waveforms



74HC175; 74HCT175

Quad D-type flip-flop with reset; positive-edge trigger





Measurement points are given in Table 8.

Fig 10. Master reset to output propagation delays, master reset pulse width and master reset to clock recovery time

Table 8.Measurement points

| Туре | Input | | Output |
|----------|-----------------|--------------------|--------------------|
| | VI | V _M | V _M |
| 74HC175 | V _{CC} | 0.5V _{CC} | 0.5V _{CC} |
| 74HCT175 | 3 V | 1.3 V | 1.3 V |

74HC_HCT175 Product data sheet

74HC175; 74HCT175

Quad D-type flip-flop with reset; positive-edge trigger

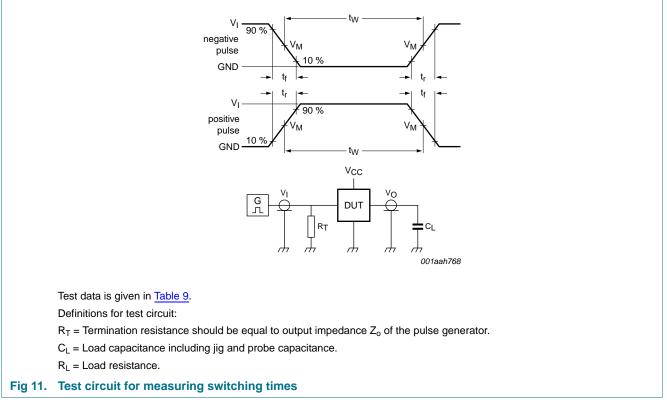


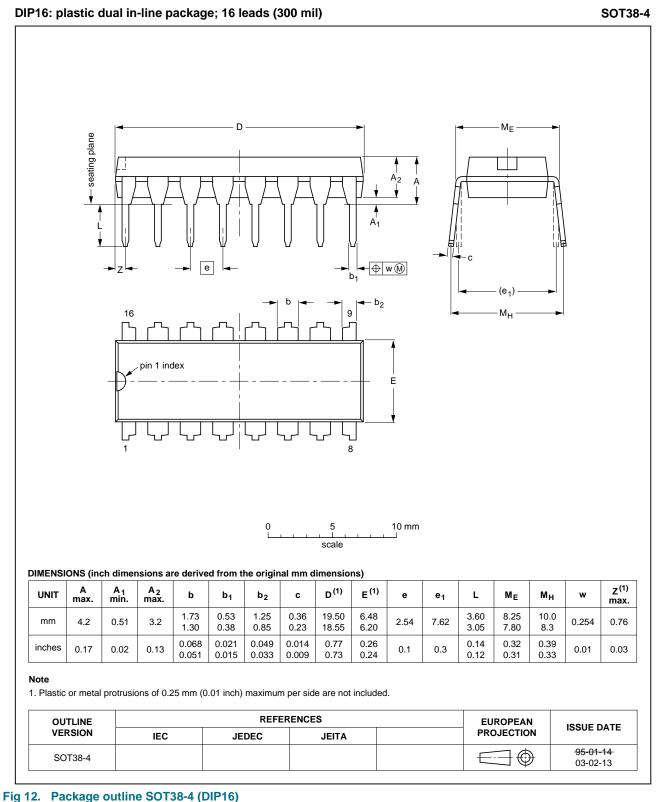
Table 9. Test data

| Туре | Input | | Load | | Test |
|----------|-----------------|---------------------------------|--------------|------|-------------------------------------|
| | VI | t _r , t _f | CL | RL | |
| 74HC175 | V _{CC} | 6 ns | 15 pF, 50 pF | 1 kΩ | t _{PLH} , t _{PHL} |
| 74HCT175 | 3 V | 6 ns | 15 pF, 50 pF | 1 kΩ | t _{PLH} , t _{PHL} |

74HC175; 74HCT175

Quad D-type flip-flop with reset; positive-edge trigger

12. Package outline



74HC_HCT175 **Product data sheet**

Quad D-type flip-flop with reset; positive-edge trigger

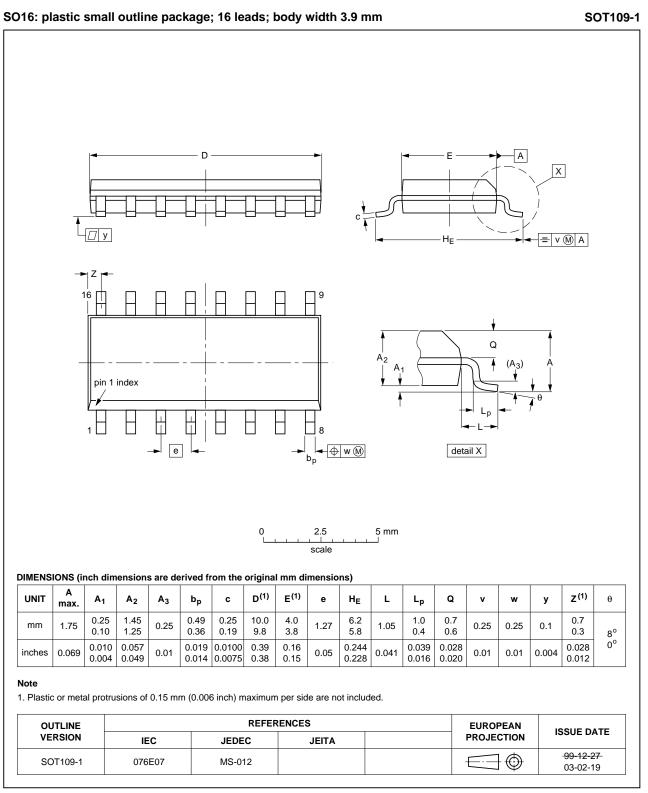


Fig 13. Package outline SOT109-1 (SO16)

74HC_HCT175 Product data sheet

Quad D-type flip-flop with reset; positive-edge trigger

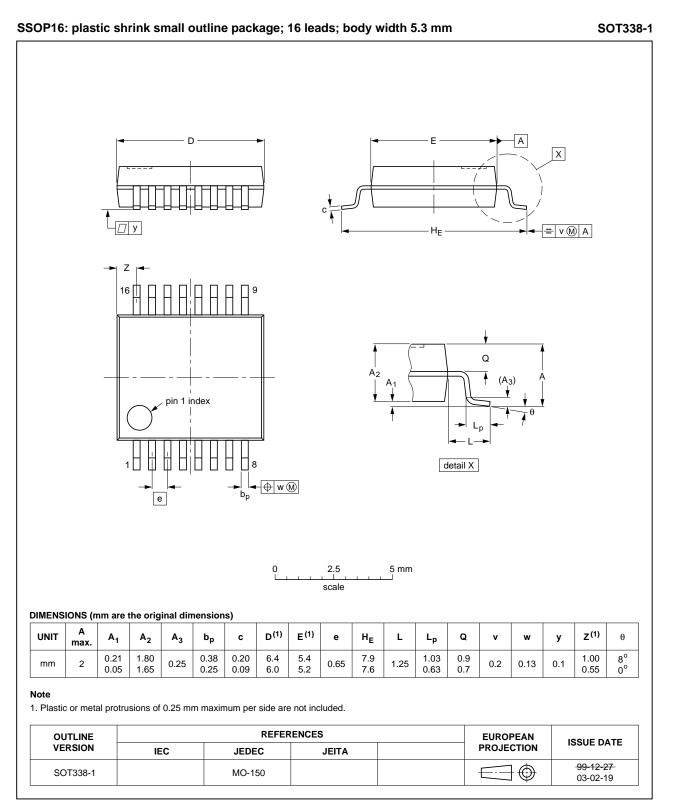


Fig 14. Package outline SOT338-1 (SSOP16)

74HC_HCT175 Product data sheet

Quad D-type flip-flop with reset; positive-edge trigger

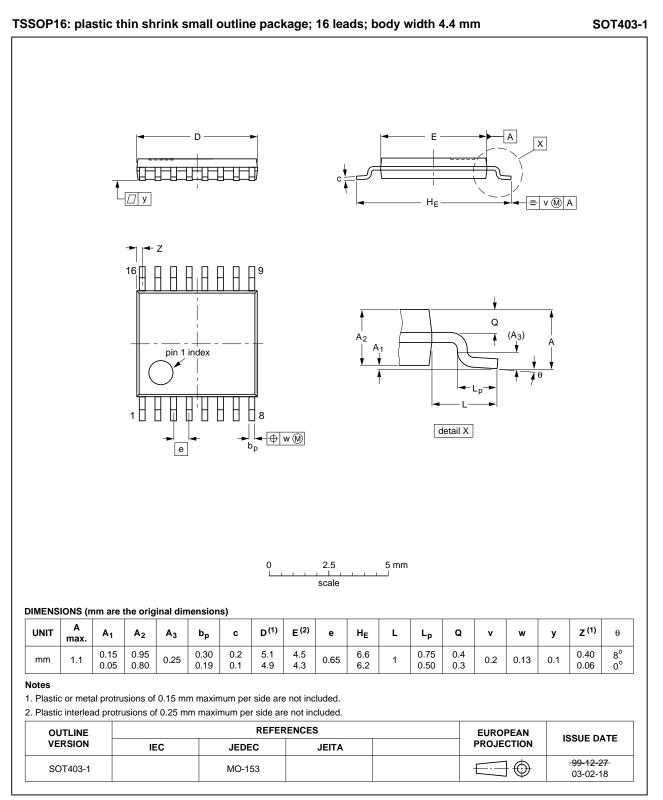


Fig 15. Package outline SOT403-1 (TSSOP16)

74HC_HCT175 Product data sheet

Quad D-type flip-flop with reset; positive-edge trigger

13. Abbreviations

| Table 10. Abbreviations | | |
|-------------------------|---|--|
| Acronym | Description | |
| CMOS | Complementary Metal-Oxide Semiconductor | |
| DUT | Device Under Test | |
| ESD | ElectroStatic Discharge | |
| НВМ | Human Body Model | |
| MM | Machine Model | |
| TTL | Transistor-Transistor Logic | |

14. Revision history

Table 11. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|-------------------|---|-----------------------|---------------|-------------------|
| 74HC_HCT175 v.4 | 20140408 | Product data sheet | - | 74HC_HCT175 v.3 |
| Modifications: | General description corrected (errata). | | | |
| 74HC_HCT175 v.3 | 20140331 | Product data sheet | - | 74HC_HCT175_CNV_2 |
| Modifications: | The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. | | | |
| | Legal texts have been adapted to the new company name where appropriate. | | | |
| 74HC_HCT175_CNV_2 | 19980708 | Product specification | - | - |

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| Document status[1][2] | Product status ^[3] | Definition |
|--------------------------------|-------------------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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74HC HCT175

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74HC175; 74HCT175

Quad D-type flip-flop with reset; positive-edge trigger

17. Contents

| 1 | General description 1 |
|------|------------------------------------|
| 2 | Features and benefits 1 |
| 3 | Ordering information 1 |
| 4 | Functional diagram 2 |
| 5 | Pinning information 3 |
| 5.1 | Pinning 3 |
| 5.2 | Pin description 3 |
| 6 | Functional description 4 |
| 7 | Limiting values 4 |
| 8 | Recommended operating conditions 5 |
| 9 | Static characteristics 5 |
| 10 | Dynamic characteristics 7 |
| 11 | Waveforms 9 |
| 12 | Package outline 12 |
| 13 | Abbreviations 16 |
| 14 | Revision history 16 |
| 15 | Legal information 17 |
| 15.1 | Data sheet status 17 |
| 15.2 | Definitions 17 |
| 15.3 | Disclaimers |
| 15.4 | Trademarks |
| 16 | Contact information 18 |
| 17 | Contents 19 |

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